506148920 07/10/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SZU-CHI YANG	03/06/2020
ALLEN CHIEN	03/06/2020
CHENG-TING DING	03/06/2020
CHIEN-CHIH LIN	03/06/2020
CHIEN-CHIH LEE	03/06/2020
SHIH-HAO LIN	03/06/2020
TSUNG-HUNG LEE	03/10/2020
CHIH CHIEH YEH	03/06/2020
PO-KAI HSIAO	03/06/2020
TSAI-YU HUANG	03/06/2020

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16926528

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PATENT 506148920 REEL: 053179 FRAME: 0759

ATTORNEY DOCKET NUMBER:	2019-2311/24061.4052US01
NAME OF SUBMITTER:	MARIA TEDESCO
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DATE SIGNED:	07/10/2020
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PATENT REEL: 053179 FRAME: 0760



Docket No.: P20192311US00/ 24061.4052US01

Customer No.: 000042717

ASSIGNMENT

WHEREAS, we,

(1)	Szu-Chi Yang	of	Hsinchu, Taiwan (R.O.C)
(2)	Allen Chien	of	Hsinchu, Taiwan (R.O.C)
(3)	Cheng-Ting Ding	of	Hsinchu, Taiwan (R.O.C)
(4)	Chien-Chih Lin	of	Hsinchu, Taiwan (R.O.C)
(5)	Chien-Chih Lee	of	New Taipei City, Taiwan (R.O.C)
(6)	Shih-Hao Lin	of	Hsinchu, Taiwan (R.O.C)
(7)	Tsung-Hung Lee	of	Hsinchu City, Taiwan (R,O.C)
(8)	Chih Chieh Yeh	of	Taipei City, Taiwan (R.O.C)
(9)	Po-Kai Hsiao	of	Changhua County, Taiwan (R.O.C)
(10)	Tsai-Yu Huang	of	Hsinchu, Taiwan (R.O.C)

have invented certain improvements in

INTERFACE TRAP CHARGE DENSITY REDUCTION

for which we have executed an application for Letters Patent of the United States of America,

X	of even date filed l	nerewith; and	
***************************************	filed on	and assigned application number _	: and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, Taiwan Semiconductor Manufacturing Co., Ltd., ("TSMC"), 8, Li-Hsin Rd. 6, Hsinchu Science Park, Hsinchu, Taiwan 300-78, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all

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PATENT REEL: 053179 FRAME: 0761 Docket No.: P20192311US00/24061.4052US01

Customer No.: 000042717

prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

*		A 11	
mve	ntor	Name:	

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Docket No.: P20192311US00/ 24061.4052US01

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Docket No.: P20192311US00/24061.4052US01

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Dated 3/6/2020

Inventor Signature

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RECORDED: 07/10/2020